Tagger Microscope for Hall D

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Outline

Microscope Design

Properties of the Focal Plane Design Overview Approach to Readout

Design Implementation

Optics Electronics Prototyping and Outlook

Properties of the Focal Plane Design Overview Approach to Readout

GlueX Photon Spectrum

Bremsstrahlung in diamond crystal:

- coherent edges
- incoherent background

Beam collimation strongly reduces this background.



- full spectrum
- collimated beam
- total coverage by broad-band hodoscope
 range of interest to GlueX instrumented with a tagger "microscope"

Properties of the Focal Plane Design Overview Approach to Readout

GlueX Photon Spectrum



total coverage by broad-band hodoscope
 range of interest to GlueX - instrumented with a tagger "microscope"

Requirements

Design requirements of the Hall D tagger:

Category		Requirement source/reason
energy resolution	$60{ m MeV}$	GlueX detector capability
time resolution	$200\mathrm{ps}$	accurate bunch identification
rate	$2\mathrm{MHz}$	collimated spectral peak
tagging efficiency	50%	

The rate limitation presents a more stringent requirement for focal plane segmentation.

Properties of the Focal Plane Design Overview Approach to Readout

Focal Plane Geometry





- SciFi detectors 2 cm-long occupy the e⁻ focal plane aligned along e⁻ trajectories
- ▶ fiber waveguides ~ 0.5 m-long couple to detectors mounted above
- β varies with energy (steep dependence at the low E_{e⁻} limit.)

Properties of the Focal Plane Design Overview Approach to Readout

Focal Plane Segmentation

Electron's view of the 100×5 scintillator array



- ▶ $2 \times 2 \, \mathrm{mm^2}$ cross-section SciFi array
 - small acceptance to mitigate rate
 - ▶ resulting $\sim 8 \, {\rm MeV}$ resolution more than satisfies GlueX requirement
- Tagging efficiency improvement:
 - vertical segmentation +
 - limiting tags to one row
- Economy of readout channels
 - vertically summed
 - read individually for 2D sensitivity

Transverse distribution of electrons.



Properties of the Focal Plane Design Overview Approach to Readout

Conceptual Design

Design features:

- electronics out of the e⁻ plane: SciFi/photo-detector coupling via waveguides
- SiPM-based readout
 - custom amp. board
 - bias voltage control board
- full microscope: 20 board-fiber groups



Properties of the Focal Plane Design Overview Approach to Readout

Mechanical Structure



Properties of the Focal Plane Design Overview Approach to Readout

Scintillator Alignment



- rotation DOFs: convenient during alignment
- vertical translation: allows selection of scintillator row
- β fixed during assembly

- - focal plane location
- electron trajectory
- available DOFs after assembly

Properties of the Focal Plane Design Overview Approach to Readout

Alignment of Fiber Modules





electron energy (GeV)

Support frame for fiber modules designed to allow alignment with all crossing angles for the useful energy range.

Properties of the Focal Plane Design Overview Approach to Readout

Choice of Photo-detector

Photo-detector technology chosen: Silicon Photomultipliers (SiPMs)

- comparable in speed and gain to PMTs
- ▶ high voltage not required ($V_{bias} < 100 \, \text{V}$)
- size of order 1 mm matches fiber cross-section



SSPM-0606BG4

Three SiPM devices were considered:

Firm	Device	Area (mm ²	?)
Hamamatsu	050C	1	after-pulsing, inadequate efficiency
Photonique	050701GR	1	inadequate efficiency
Photonique	0606BG4	4.4	meets requirements

Properties of the Focal Plane Design Overview Approach to Readout

Candidate SiPM

Best unit found: Photonique SSPM-0606BG4

Active window	$(2.1{ m mm})^2$	matches $2\mathrm{mm}$ square fibers
Pixel number	1700	good dynamic range for $200\mathrm{ps}$
		resolution (discussed later)
PDE	$\sim 20\%$	sufficient for expected pulses
Gain	$\sim 2 \times 10^5$	
Rise/recovery time	$3\mathrm{ns}/25\mathrm{ns}$	$\sim~95\%$ detection efficiency @
		$2\mathrm{MHz}$ rate
Dark rate	$10-20\mathrm{MHz}$	negligible for set discriminator
		threshold ¹

 1under the very conservative estimate of 20 MHz dark rate with cross-talk factor of 2, a threshold of 50 p.e. is crossed at a rate of $1\times10^{-43}\,Hz$

Properties of the Focal Plane Design Overview Approach to Readout

Choice of Scintillating Fiber



Features of BCF-20 scintillator

- close to peak of SiPM sensitivity and BCF-98 transmission
- ▶ fast decay time: 2.7 ns
- square, double-clad

Properties of the Focal Plane Design Overview Approach to Readout

Radiation Hardness

- **SiPM**: PDE degradation < 1 %/year based on:
 - radiation damage studies of Majos et al. (NIM A 2008) and Bohn et al. (NIM A 2008)
 - JLab Radiation Control Dépt. report on Hall D shielding by Abkemeier et al.
 - beam current of $3\,\mu A$
 - average radiation dose on south wall of tagger hall (significant overestimate: includes load of the beam itself)
 - beam duty cycle of 1/3
- ▶ Scintillator: expected lifetime ~ 1 year based on:
 - Busjan et al. (NIM B 1999) study of the more sensitive BCF-12
 - \blacktriangleright full beam intensity peak rate of $2\,\rm MHz$
 - beam duty cycle of 1/3
 - scintillator rejection threshold: 75 % output

Properties of the Focal Plane Design Overview Approach to Readout

Time Resolution

Critical Requirement: 200 psScintillator BCF-20 decay time: 2.7 ns \implies > 180 p.e. needed

Photo-detector acceptance:

- \blacktriangleright optical (light capture in fiber, transmission, misalignment): $\sim 4\%$
- SiPM PDE (geometric and quantum efficiencies): $\sim 20\%$

The expected $32 \times 10^3 \gamma$ in 2 cm of scintillator yield ~ 250 p.e.

Reflective scintillator coating on upstream end can nearly double this figure!

Properties of the Focal Plane Design Overview Approach to Readout

Overall Detector Schematic



Properties of the Focal Plane Design Overview Approach to Readout

Case for Individual Bias Control



Sensitivity to ambient temperature (${\sim}2\%/^\circ C$) and performance variability from one unit to the next demands individual bias voltage control (${\sim}40\%/V.$) Compensation for shortcomings in optics is also convenient.

Optics Electronics Prototyping and Outlook

Preparing Fibers and Coupling to Sensors



Figure: Fibers cut and polished in bundles (left), glued in arrays (right) and coated to prevent crosstalk. The fixture on the right is also used for coupling fibers to sensor array.

Optics Electronics Prototyping and Outlook

Electronics Overview

Control board:

- FPGA-centered design
- control through ubiquitous, robust, address-aware Ethernet
- ▶ V_{bias} via DAC: 32-chan., $14 \text{ bit}, \leq 200 \text{ V}$
- on-board health sensors (Temp., ADC)

Amplifier boards contain:

- array of up to 32 SiPMs
- fast, two-stage transimpedance amplifiers
- summing circuitry
- board temperature sensor $(\pm 0.5^{\circ}C)$
- precision connectors for alignment with optics



Optics Electronics Prototyping and Outlook

Digital Control Board PCB Layout







Figure: Layout, PCB and 3D rendering of the eventually populated Digital Control Board.

Optics Electronics Prototyping and Outlook

SiPM Bias and Pre-Amplification



Transimpedance amplifier - closely modeled after the one provided by the SiPM vendor

- 2-stage device: amplifier and driver
- $\sim 3 \mathrm{k} \Omega$ gain @ $V_{cc} = 5 \mathrm{V}$
- $\sim 25 \, \mathrm{ns}$ fall time given C_{SiPM}

Optics Electronics Prototyping and Outlook

Design and Layout of Pre-Amp for Microscope Use

Adaptation of amplifier for operation in microscope

- summing circuit with input drivers added
- pre-amp component values optimized for:
 - expected signals from optics+SiPM
 - ▶ operation with an 8 bit (0.5 2 V range), 250 MHz fADC for online testing
 - controllable gain up into single photon counting range (useful for testing with built-in pulser)
 - \blacktriangleright insensitivity to variation of transistor β
 - short pulses for higher rate capability

Work in progress:

- Amplifier prototyping
- PCB Layout of the full 32-amp board





Optics Electronics Prototyping and Outlook

Microscope Prototype

Realistic test of microscope design:

- all electronic, optical and mechanical components tested
- scaled to 5% of full channel count
- ▶ 46 cm × 30 cm × 46 cm enclosure
- currently being assembled for testing



Summary

The Hall D tagger microscope design presents:

- excellent timing resolution
- high energy resolution ($8 \,\mathrm{MeV}$ in range of interest to GlueX)
- exploits vertical focusing of tagger optics
- enhanced tagging efficiency through vertical segmentation to match collimator acceptance
- compact, low-voltage readout design through use of SiPMs
- versatile electronics for amplification and monitoring
- flexible design for use anywhere along the focal plane

Outlook

- Prototype beam test: 2009-2010
- ▶ Full microscope construction scheduled for 2011

Distribution of Bremsstrahlung Photons

Distribution of bremsstrahlung γ 's in angle and energy

- coherent
- incoherent

